



Oxide Reliability

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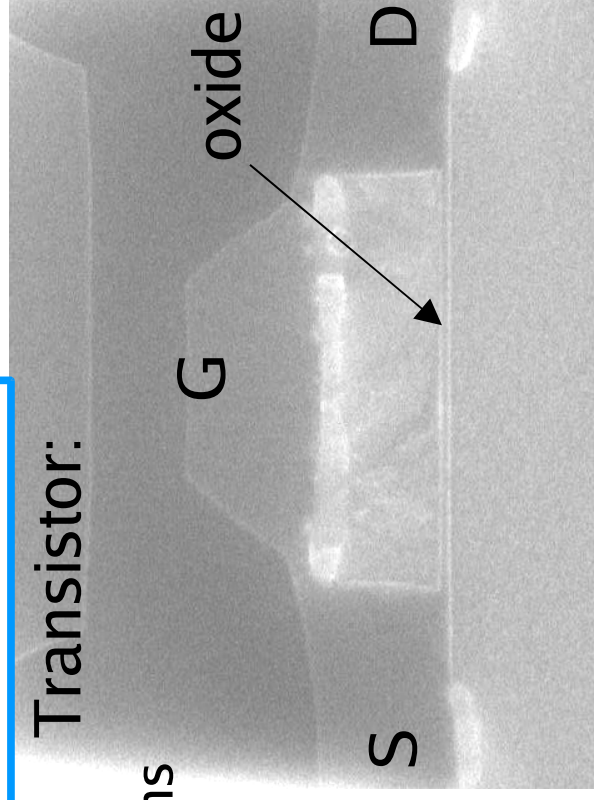
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Reliability is the probability that a component meets a determined mission in a determined environment for a determined period of time.

- ▮ The challenge of reliability investigations
- ▮ The oxide under Stress
- ▮ The Weibull statistic

Transistor:



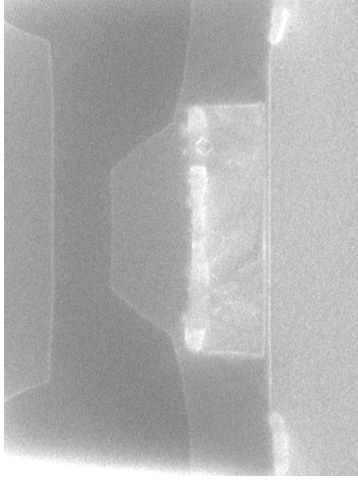
The Evolution of Transistors:

1947 : Invention of the bipolar Transistor, by Bardeen, Brattain, Shockley.

1958 : Kilby invents the integrated circuit.

today : Pentium II, 0.35 micrometer technology, 7 500 000 transistors.

STM std. techn: $0.2 < L < 0.5$ (Micrometer)
 $30 < t_{\text{ox}} < 50$ (nanometer)



The challenge of Reliability investigations:

Telephone switching system with 100 000 Transistors,
one failure per month.
$$= \frac{1 \text{ Failure}}{10^5 \text{ Devices} \times 720 \text{ Hours}} = 14 \times 10^{-9} \frac{\text{Failure}}{\text{Devicehour}} \approx 10 \text{ FIT}$$

For 100 Devices on Test

Failure rate	Time for 1 failure [years]
10 FIT	114
100 FIT	11
1000 FIT	1

If we run 500 devices for
6 month with no failure

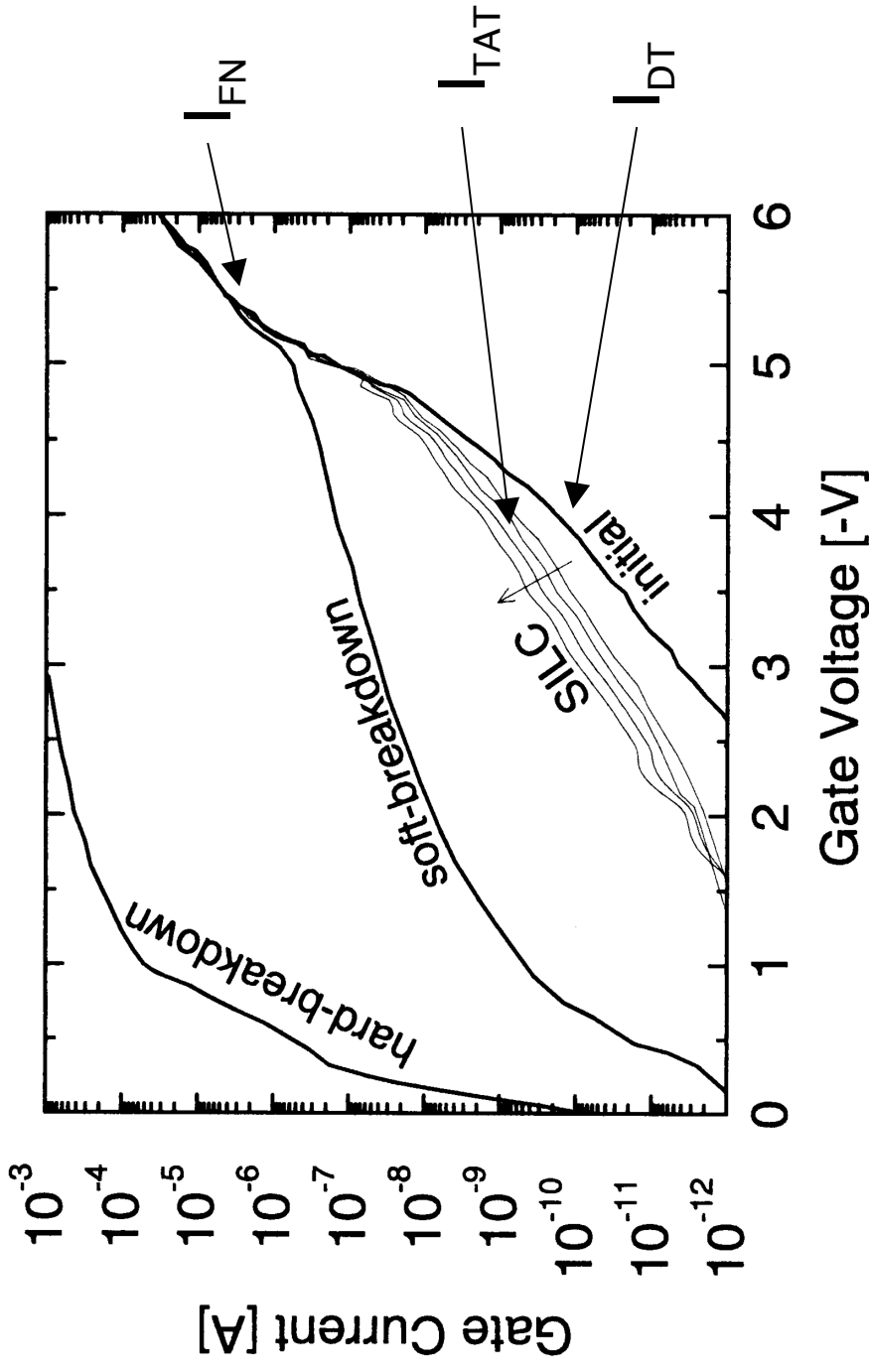
Confidence level	Failure rate
best estimate	325 FIT
60	430 FIT
90	1100 FIT

Accelerated tests are needed !

[1]A. Birolini, Reliability Engineering, Springer Verlag, Berlin 1999.

The oxide under stress

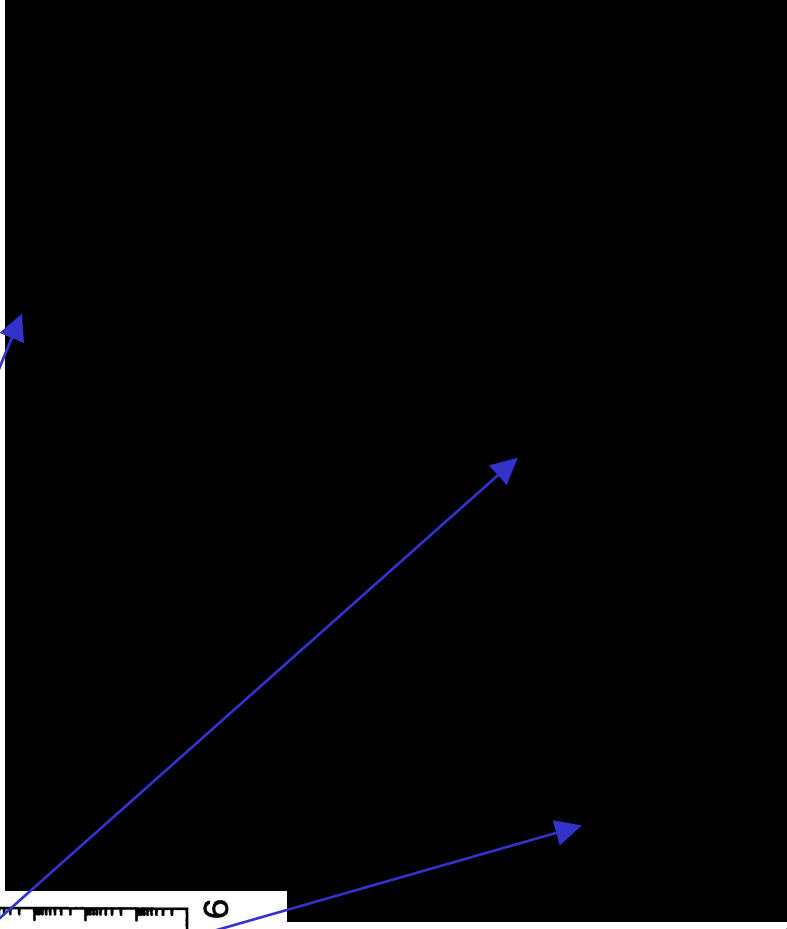
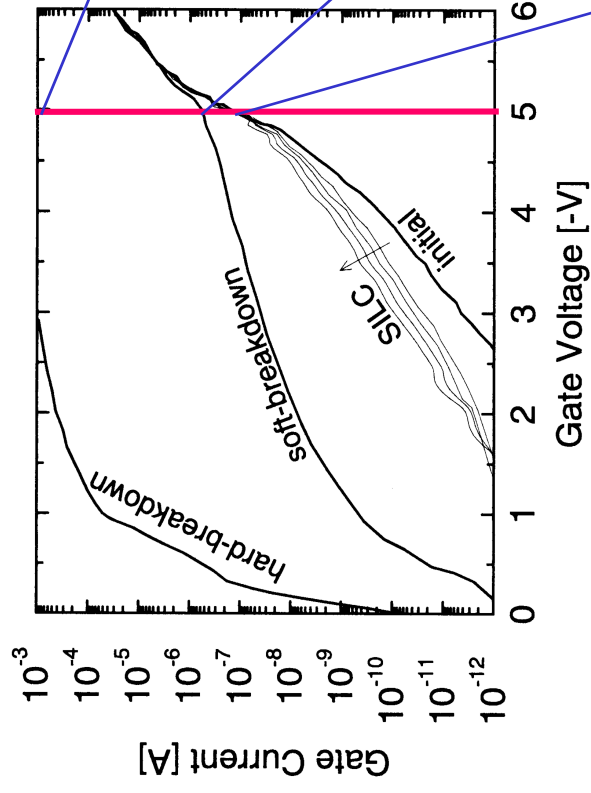
IV-curve:



[1] K.Okada, JJAP 36, 1443 (1997).

Accelerated Test:

Constant Voltage Stress



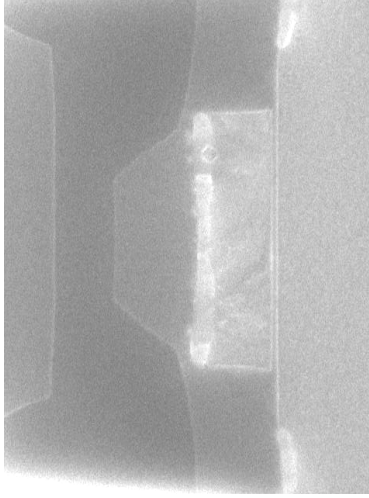
[1] K.Okada, JJAP 36, 1443 (1997).

Accelerated Test (Summary):

“After 10 years of operation at the nominal conditions (voltage, temperature) at most 100 devices per Million can be broken.” [2]

Accelerated tests to reach a high percentile of failures.

To predict failure rate at working conditions:



Scaling in Area
Voltage
Temperature

You have to know the scaling laws!

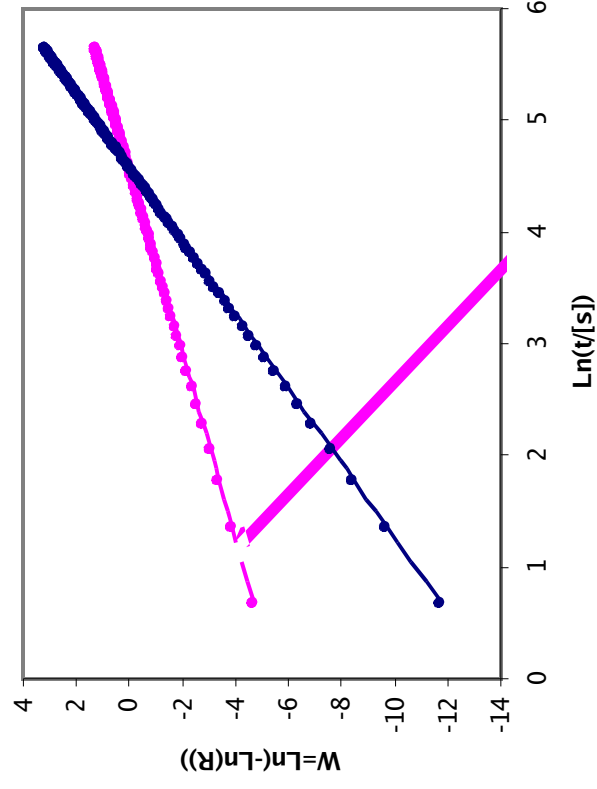
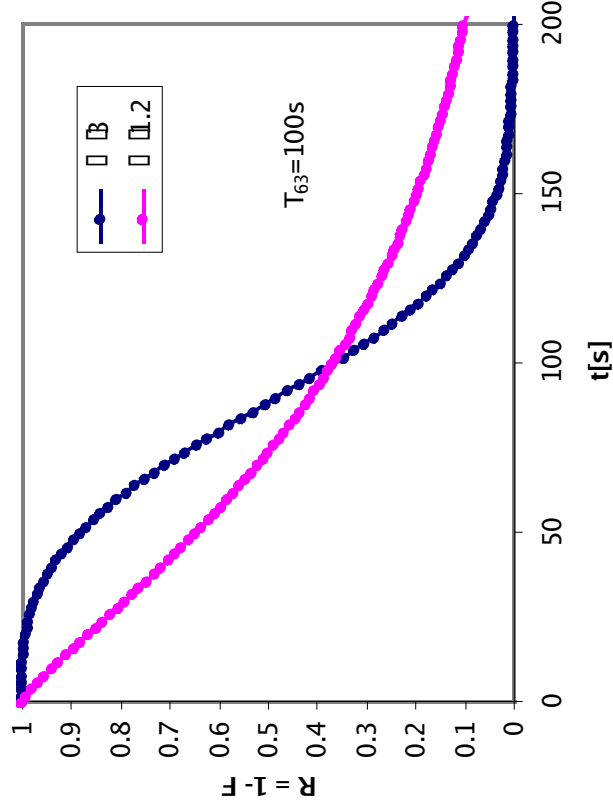
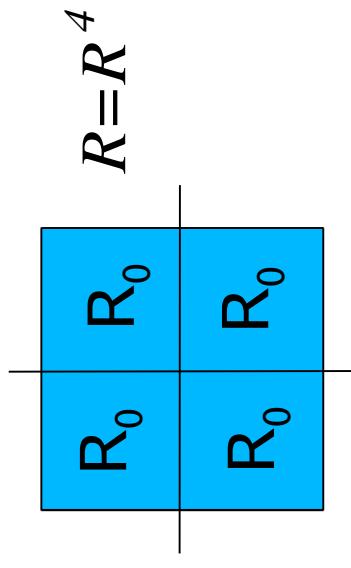
[2] International Technology Roadmap for Semiconductors 2001

e.g. Scaling in Area:

Weibull Distribution (weakest link problem)

$$\text{Reliability: } R(t) = e^{-\left(t/T_{63}\right)^{\beta}}$$

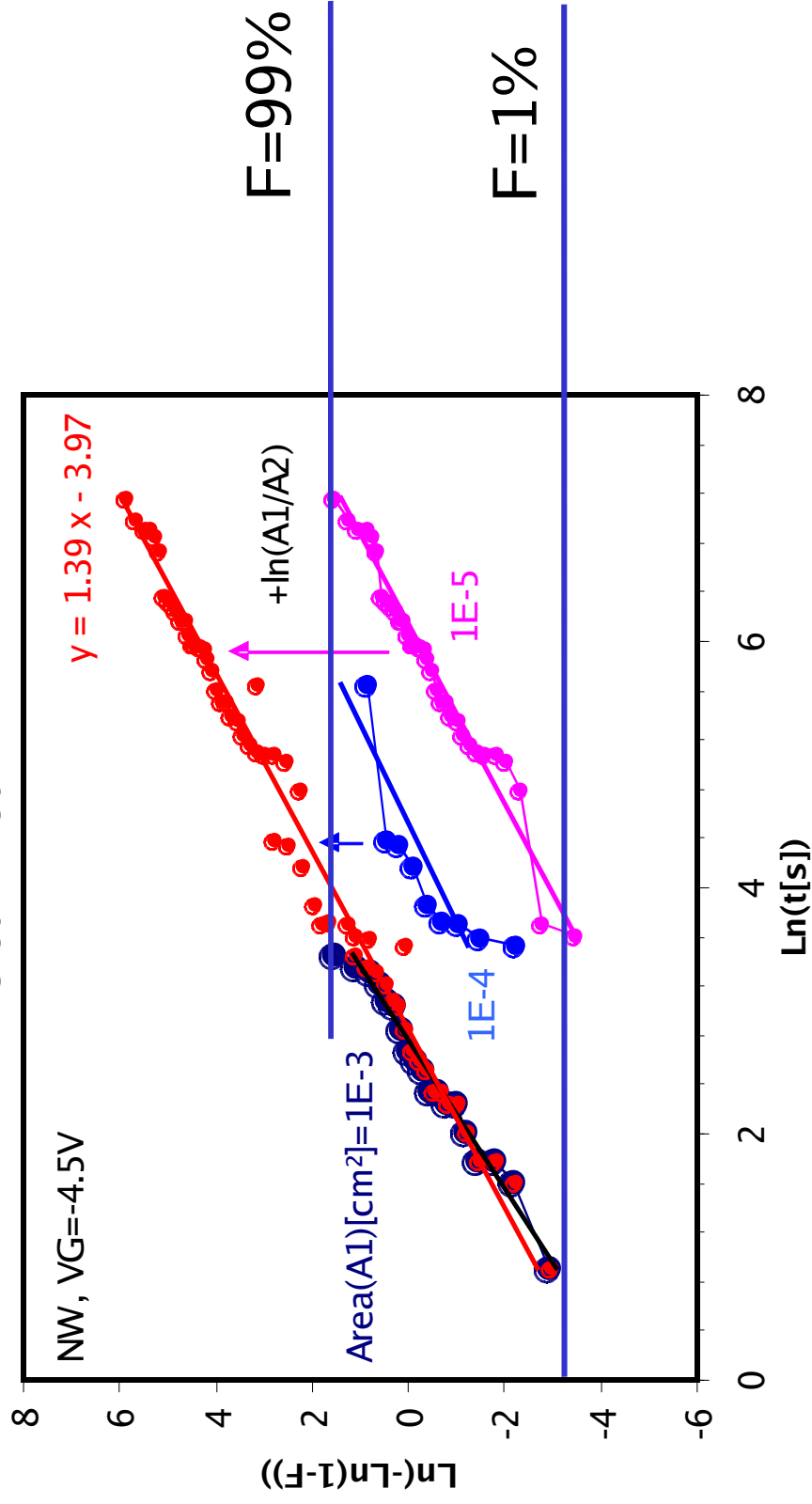
β : Weibull slope



Area Scaling:

$$T_{63}(A) = T_{63_{Test}} \cdot \left(\frac{A_{Test}}{A} \right)^{\frac{1}{\gamma}}$$

Weibull Plot



Summary:

Estimation of life time for components is important to have a useful system.

Accelerated tests are needed:

e.g.: Constant Voltage Stress
Area scaling with Weibull statistic

Literature:

VLSI Technology, edited by S.M. Sze AT&T Bell Laboratories, McGraw-Hill Book Company, Singapore 1995.

Reliability Engineering, A. Birolini, Springer Verlag, Berlin 1999.

International Technology Roadmap for

Semiconductor, Semiconductor Industry Association

<http://public.itrs.net> , 2002.